# onsemi

# <u>Silicon Carbide (SiC)</u> <u>MOSFET</u> – 20 mohm, 900 V, M2, TO-247-4L

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
900 V	28 mΩ @ 15 V	118 A

# NVH4L020N090SC1

### Features

- Typ.  $R_{DS(on)} = 20 \text{ m}\Omega @ V_{GS} = 15 \text{ V}$ Typ.  $R_{DS(on)} = 16 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge (typ.  $Q_{G(tot)} = 196 \text{ nC}$ )
- Low Effective Output Capacitance (typ. Coss = 296 pF)
- 100% UIL Tested
- AEC–Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb–Free 2LI (on second level interconnection)

# **Typical Applications**

- Automotive Traction Inverters
- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

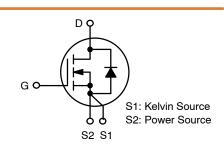
Para	Symbol	Value	Unit		
Drain-to-Source Volta	Drain-to-Source Voltage			900	V
Gate-to-Source Voltag	ge		V <sub>GS</sub>	+22/-8	V
Recommended Operate Values of Gate-Source		T <sub>C</sub> < 175°C	V <sub>GSop</sub>	+15/–5	V
$\begin{array}{c} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$	Steady State	$T_{C} = 25^{\circ}C$	I <sub>DC</sub>	116	A
Power Dissipation $R_{\theta JC}$			P <sub>DC</sub>	484	W
$\begin{array}{c} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$	Steady State	$T_{\rm C}$ = 100°C	I <sub>DC</sub>	82	A
Power Dissipation $R_{\theta JC}$			P <sub>DC</sub>	242	W
Pulsed Drain Current (	Note 2)	$T_A = 25^{\circ}C$	I <sub>DM</sub>	504	А
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C
Source Current (Body Diode)			۱ <sub>S</sub>	106	А
Single Pulse Drain-to- Energy (I <sub>L</sub> = 23 A <sub>pk</sub> , L			E <sub>AS</sub>	264	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature.

3. E<sub>AS</sub> of 264 mJ is based on starting T<sub>J</sub> = 25°C; L = 1 mH, I<sub>AS</sub> = 23 A, V<sub>DD</sub> = 100 V, V<sub>GS</sub> = 15 V.



N-CHANNEL MOSFET



**MARKING DIAGRAM** 

H4L020 090SC1 &Z&3&K \$Y H4L020090SC1 = Specific Device Code &Z = Assembly Plant Code &3 = Date Code (Year & Week) &K = Lot \$Y = onsemi Logo

# **ORDERING INFORMATION**

See detailed ordering and shipping information on page 6 of this data sheet.

#### Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Мах	Unit
Thermal Resistance Junction-to-Case (Note 1)	$R_{ extsf{ heta}JC}$	0.31	°C/W
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

# Table 2. ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-						
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ =	1 mA	900			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	I <sub>D</sub> = 1 mA, refer	to 25°C		500		mV/∘C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			100	μΑ
		V <sub>DS</sub> = 900 V	T <sub>J</sub> = 175°C			250	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = +22/-8 V	, V <sub>DS</sub> = 0 V			±1	μΑ
ON CHARACTERISTICS							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$ , $I_D$	= 20 mA	1.8	2.7	4.3	V
Recommended Gate Voltage	V <sub>GOP</sub>			-5		+15	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$ $V_{GS} = 18 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$ $V_{GS} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$			20	28	mΩ
					16		7
					27		
Forward Transconductance	9 <sub>FS</sub>	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 60 \text{ A}$			49		S
CHARGES, CAPACITANCES & GATE RI	ESISTANCE						
Input Capacitance	C <sub>ISS</sub>	$V_{GS} = 0 V, f = 1 MHz,$			4415		pF
Output Capacitance	C <sub>OSS</sub>	V <sub>DS</sub> = 450 V			296		
Reverse Transfer Capacitance	C <sub>RSS</sub>				24		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS} = -5/15 V$ ,	V <sub>DS</sub> = 720 V,		196		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	I <sub>D</sub> = 60 A			42		
Gate-to-Source Charge	Q <sub>GS</sub>				78		
Gate-to-Drain Charge	Q <sub>GD</sub>				55		1
Gate-Resistance	R <sub>G</sub>	f = 1 MHz			1.6		Ω
SWITCHING CHARACTERISTICS	•	•		•	•	•	•
Turn-On Delay Time	t <sub>d(ON)</sub>	V <sub>GS</sub> = -5/15 V,	V <sub>DS</sub> = 720 V,		29		ns
Rise Time	tr	I <sub>D</sub> = 60 A, R <sub>G</sub> = Inductive Load	2.5 Ω,		28		1
Turn-Off Delay Time	t <sub>d(OFF)</sub>	1			54		

Rise Time	t <sub>r</sub>	Inductive Load		28		
Turn-Off Delay Time	t <sub>d(OFF)</sub>			54		
Fall Time	t <sub>f</sub>			14		
Turn-On Switching Loss	E <sub>ON</sub>			611		μJ
Turn-Off Switching Loss	E <sub>OFF</sub>			293		
Total Switching Loss	E <sub>TOT</sub>			904		
DRAIN-SQUBCE DIODE CHABACTERISTICS						

#### DRAIN-SOURCE DIODE CHARACTERISTICS

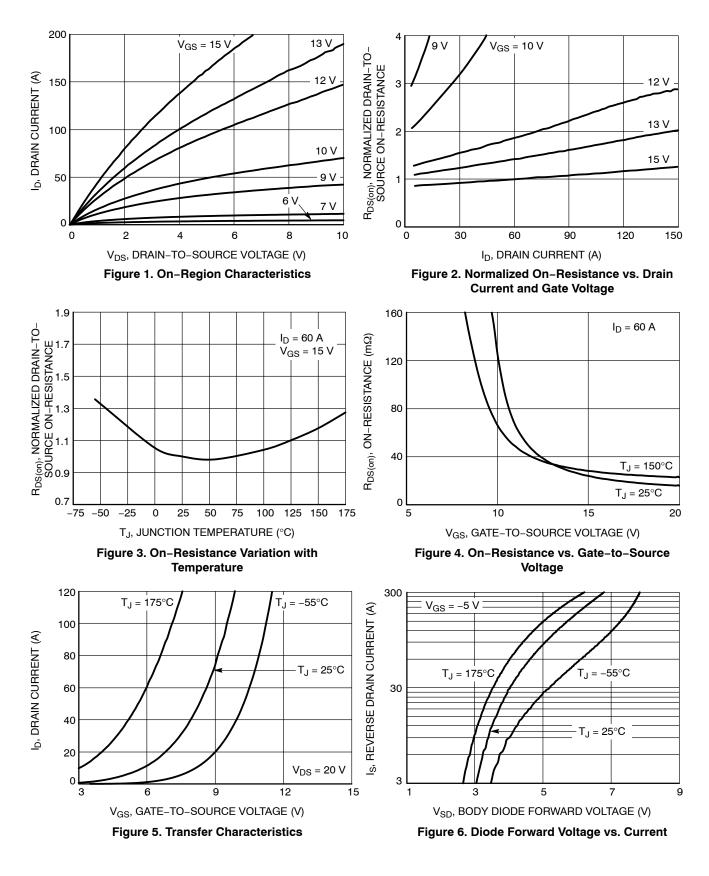
Continuous Drain-Source Diode Forward Current	I <sub>SD</sub>	$V_{GS}$ = -5 V, $T_J$ = 25°C		106	A
Pulsed Drain-Source Diode Forward Current (Note 2)	I <sub>SDM</sub>	$V_{GS}$ = -5 V, $T_{J}$ = 25°C		504	A
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS}$ = –5 V, $I_{SD}$ = 30 A, $T_{J}$ = 25°C	3.8		V

#### Table 2. ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated) (continued)

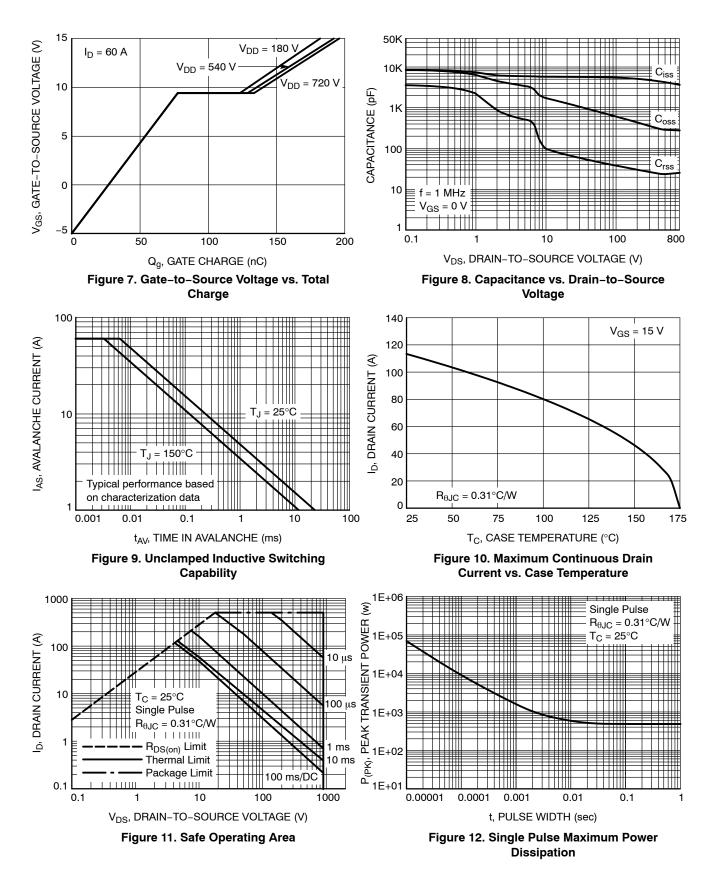
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
DRAIN-SOURCE DIODE CHARACTERISTICS								
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = -5/15 V, I <sub>SD</sub> = 60 A, dI <sub>S</sub> /dt = 1000 A/µs, V <sub>DS</sub> = 720 V		30		ns		
Reverse Recovery Charge	Q <sub>RR</sub>	$dI_{S}/dt = 1000 \text{ A}/\mu \text{s}, V_{DS} = 720 \text{ V}$		244		nC		
Reverse Recovery Energy	E <sub>REC</sub>	1		11		μJ		
Peak Reverse Recovery Current	I <sub>RRM</sub>	1		16		А		
Charge Time	Та	]		17		ns		
Discharge Time	Tb	1		13		ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **TYPICAL CHARACTERISTICS**



#### TYPICAL CHARACTERISTICS (continued)



# TYPICAL CHARACTERISTICS (continued)

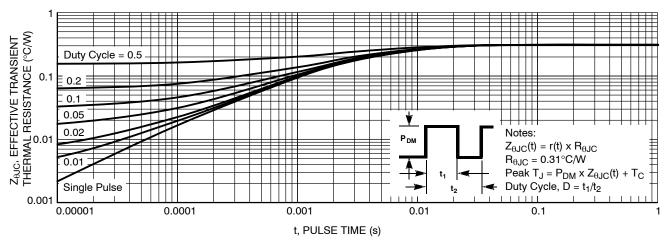


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Size	Quantity
NVH4L020N090SC1	H4L020090SC1	TO247-4L	Tube	N/A	N/A	30 Units



TO-247-4LD CASE 340CJ **ISSUE A** 

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

3.40

6.60

5.97

5.97

р p1

Q

S

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20

5.20

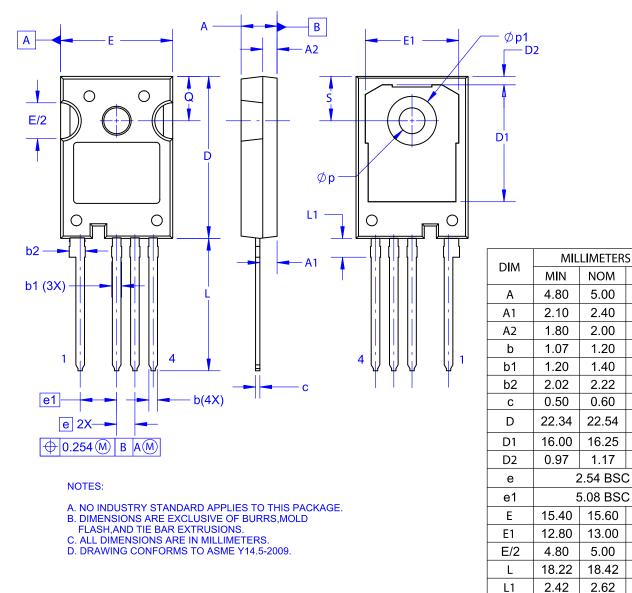
18.62

2.82

3.80

7.00 6.37

6.37



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DESCRIPTION:	TO-247-4LD		PAGE 1 OF 1			

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